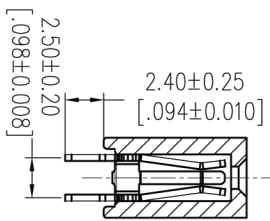
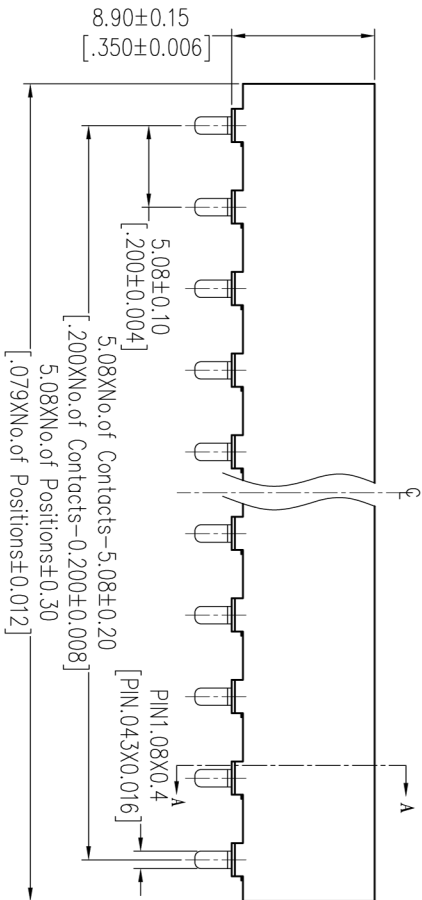
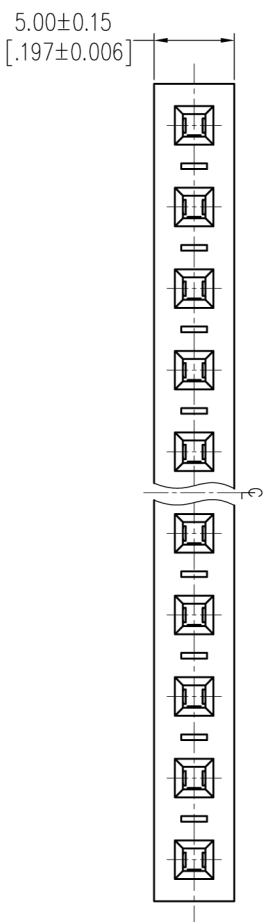
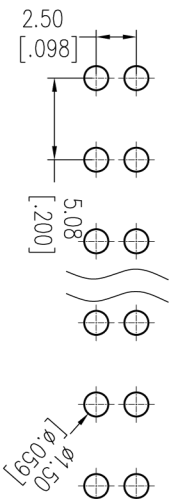


HSF

NOTES:

- Current Rating: 7.0AMP
- Contact Resistance: 30mΩ Max
- Withstand Voltage: 1000V AC/DC
- Insulation Resistance: 1000MΩ Min
- Operation Temperature: -40°C to +105°C
- Contact Material: Phosphor Bronze
- Contact plating: Sn over Ni
- Insulator Material: LCP+30%G.F UL94V-0

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



Ordering Information

2989 - 1 XX S XX D U N T 1

No. of Pins per ROW: 52=40PIN
Contact Plating: SN=Tin
SM=Matte Tin

Packing: T=Tube

| | | |
|-----------|-------|--------|
| Item | Pitch | Mating |
| Standard | 5.08 | 1925 |
| Alternate | | |

| | | | | | | | | | | | |
|-----------|------------|--------------------------|---------|------|------------|-------|----|-------|-----|--------------|----------------------------------|
| OPERATION | ±0.40 | DRAW | JYhuang | DATE | 2012/08/15 | SCALE | mm | FIT | | PART NO. | 2989-1XXSXXDUNT1 |
| XX | ±0.25 | CHECK | | DATE | | UNIT | A4 | SIZE | 1/1 | TITLE: | FHS_08 SINGLE ROW 180° DIP H=8.9 |
| XXX | ±0.15 | APPROVE | | DATE | | SHEET | | PROJ. | | Customer NO. | |
| Angle | ± 3° | CHANGE | | | | | | | | | |
| DIM | TOL | | | | | | | | | | |
| REV | DATE | MODIFICATION DESCRIPTION | | | | | | | | | |
| A0 | 2012/08/15 | NEW | | | | | | | | | |

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